Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
L2	25	("3339274" | "3959874" | "4172907" | "4616406" | "5120678" | "5148266" | "5155904" | "5241133" | "5316788" | "5397917" | "5433822" | "5436203" | "5468681" | "5581122" | "5663106" | "5663593" | "5798563" | "5824569" | "5889655" | "6229209").PN. OR ("6365499").URPN.	US-PGPUB; USPAT; USOCR	OR	ON	2005/03/14 12:21
L3	11	2 and planar$3	US-PGPUB; USPAT; USOCR	OR	ON	2005/03/14 12:21
L4	55	(circuit with (assembly or package)) and substrate and via and die and (ball or pin) and (fill or underfill or under-fill) and stacked and (dielectric with planar$3)	USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/03/14 12:26
L6	1632	257/678.ccls.	USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/03/14 12:47
L7	434	257/752.ccls.	USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/03/14 12:50
L8	1357	257/700.ccls.	USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/03/14 13:10
L9	1160	257/777.ccls.	USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/03/14 13:17
L10	1679	257/774.ccls.	USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/03/14 13:29
L11	1752	257/723.ccls.	USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/03/14 13:29
L12	7	(US-6051878-$ or US-6157080-$ or US-6165815-$ or US-6222265-$ or US-6265766-$ or US-6340846-$ or US-6365499-$).did.	USPAT	OR	ON	2005/03/14 13:56

L13	33	("4954878" | "5099306" | "5109320" | "5128831" | "5222014" | "5252857" | "5291061" | "5300801" | "5323060" | "5403784" | "5422435" | "5434745" | "5466627" | "5473814" | "5477082" | "5481134" | "5494841" | "5495398" | "5496775" | "5498902" | "5498905" | "5506756" | "5508565" | "5512765" | "5512780" | "5513076" | "5535101" | "5594275" | "5639696" | "5705858" | "5715144" | "5728606" | "5729440").PN.	US-PGPUB; USPAT; USOCR	OR	ON	2005/03/14 14:07
L21	30	("4446477" | "5218234" | "5222014" | "5293068" | "5434452" | "5486723" | "5952611" | "6013946" | "6048755" | "6091140" | "6097085").PN. OR ("6265766"). URPN.	US-PGPUB; USPAT; USOCR	OR	ON	2005/03/14 14:50
L22	292	(circuit with (assembly or package)) and substrate and via and ((die or chip) with ((ball or pin) and (fill or underfill or under-fill))) and (planar$3)	USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/03/14 15:11
L23	137	22 and package.ab.	USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/03/14 15:11
S1	10	("5422435"|"5608262"|"5811351" |"5952725"|"5994166").PN.	USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/02/22 08:29
S2	1564	(circuit with (assembly or package)) and substrate and via and die and (ball or pin) and (fill or underfill or under-fill)	USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/03/14 12:25
S3	556	S2 and stacked	USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/02/22 08:55
S4	340	S3 and dielectric	USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/02/22 08:39

S5	53	S4 and stacked.ab.	USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/02/22 08:39
S6	725	(circuit with (assembly or package)) and substrate and via and ((die or chip) with ((ball or pin) and (fill or underfill or under-fill)))	USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/03/14 15:10
S7	226	S6 and stacked	USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/02/22 08:55
S8	2	("6337227").URPN.	USPAT	OR	ON	2005/02/22 09:51
S9	5	("5323060" | "6337226" | "6337227" | "6340846" | "6492726").PN.	US-PGPUB; USPAT; USOCR	OR	ON	2005/02/22 09:52
S10	401	257/656.ccls.	USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/03/14 11:03
S11	1936	257/676.ccls.	USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/03/14 12:40
S12	6	"6613606"	USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/03/14 11:08
S13	8	("5422435" | "5608262" | "5811351" | "5952725" | "5994166" | "6114187" | "6228681" | "6365499").PN.	US-PGPUB; USPAT; USOCR	OR	ON	2005/03/14 11:09